

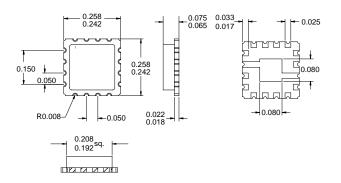
#### HIGH POWER LINEAR UHF AMPLIFIER

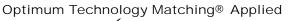
Typical Applications

- 900 MHz ISM Band Applications
- 400 MHz Industrial Radios
- Digital Communication Systems
- Driver Stage for Higher Power Applications
- Commercial and Consumer Systems
- Portable Battery-Powered Equipment

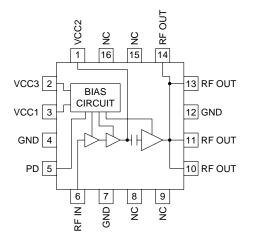
### **Product Description**

The RF2105L is a high power, high efficiency linear amplifier IC. The device is manufactured on an advanced Gallium Arsenide Heterojunction Bipolar Transistor (HBT) process, and has been designed for use as the final RF amplifier in digital cellular phone transmitters or ISM applications requiring linear amplification. It is packaged in a 16-lead ceramic package with a backside ground. The device is self-contained with the exception of the output matching network and power supply feed line.





| Si BJT     | 🗹 GaAs HBT | GaAs MESFET |
|------------|------------|-------------|
| Si Bi-CMOS | SiGe HBT   | Si CMOS     |



Functional Block Diagram

Package Style: QLCC-16 Alumina

#### Features

- Single 2.7V to 6.5V Supply
- Up to 1.2W CW Output Power
- 33dB Small Signal Gain
- 48% Efficiency
- Digitally Controlled Power Down Mode
- Small Package Outline (0.25" x 0.25")

Ordering Information RF2105L High Power Linear UHF Amplifier RF2105L PCBA Fully Assembled Evaluation Board

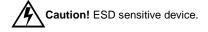
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 http://www.rfmd.com

#### **Absolute Maximum Ratings**

| Parameter                             | Rating       | Unit            |
|---------------------------------------|--------------|-----------------|
| Supply Voltage (V <sub>CC</sub> )     | -0.5 to +8.5 | V <sub>DC</sub> |
| Power Down Voltage (V <sub>PD</sub> ) | -0.5 to +6.5 | V <sub>DC</sub> |
| DC Supply Current                     | 700          | mA              |
| Input RF Power                        | +12          | dBm             |
| Output Load                           | 20:1         |                 |
| Operating Case Temperature            | -40 to +100  | °C              |
| Operating Ambient Temperature         | -40 to +85   | °C              |
| Storage Temperature                   | -40 to +150  | °C              |



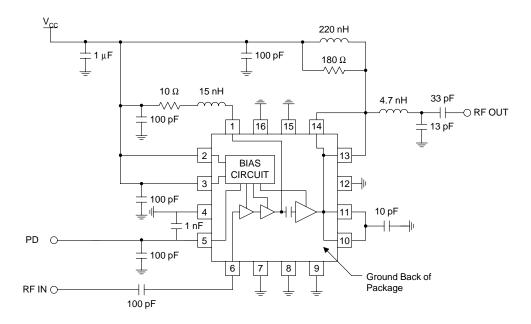
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| Parameter<br>Overall<br>Frequency Range<br>Maximum CW Output Power | Min. | <b>Typ.</b><br>430 to 930<br>+30.8 | Max. | Unit            | Condition   |
|--|------|------------------------------------|------|-----------------|---|
| Frequency Range  |      |                                    |      |                 |   |
| Frequency Range  |      |                                    |      |                 | T=25°C, V <sub>CC</sub> =5.8V, V <sub>PD</sub> =5.8V, Z <sub>LOAD</sub> =9Ω,                  |
|  |      |                                    |      |                 | P <sub>IN</sub> =0dBm, Freq=840MHz  |
|  |      |                                    |      | MHz<br>dBm      | V <sub>CC</sub> =5.8V, V <sub>PD</sub> =5.8V, Z <sub>LOAD</sub> =9Ω                           |
|  |      | 100.0                              |      | ubiii           | Note that increasing $V_{CC}$ above 5.8V does<br>not result in higher output power; power may |
|  |      | <u> </u>                           |      | 15              | actually decrease.  |
|  |      | +29.3                              |      | dBm             | $V_{CC}$ =5.0V, $V_{PD}$ =5.0V, $Z_{LOAD}$ =9 $\Omega$  |
|  |      | +28.5                              |      | dBm             | $V_{CC}$ =4.4V, $V_{PD}$ =4.4V, $Z_{LOAD}$ =9 $\Omega$  |
|  |      | +30                                |      | dBm             | $V_{CC}$ =5.8V, $V_{PD}$ =5.8V, $Z_{LOAD}$ =12 $\Omega$                                       |
|  |      | +27.8                              |      | dBm             | $V_{CC}$ =5.0V, $V_{PD}$ =5.0V, $Z_{LOAD}$ =12 $\Omega$                                       |
|  |      | +27                                |      | dBm             | $V_{CC}$ =4.4V, $V_{PD}$ =4.4V, $Z_{LOAD}$ =12 $\Omega$                                       |
| CW Efficiency at Max Output  |      | 48                                 |      | %               |   |
| DC Current at Max Output   |      | 450                                |      | mA              |   |
| Small-signal Gain<br>Second Harmonic                               |      | 33<br>-23                          |      | dB<br>dBc       | Without ovtornal accord harmonia tran   |
| Third Harmonic   |      | -23<br>-36                         |      | dBc             | Without external second harmonic trap   |
| Fourth Harmonic  |      | -35                                |      | dBc             |   |
| Input VSWR   |      | <2:1                               |      | abo             | With external matching network; see appli-<br>cation schematic                                |
| Input Impedance  |      | 50                                 |      | Ω               | With external matching network; see appli-<br>cation schematic                                |
| Two-Tone Specification   |      |                                    |      |                 |   |
| Average Two-Tone Power   |      | +27.0                              |      | dBm             | PEP-3dB   |
| IM <sub>3</sub>  |      | -30                                | -25  | dBc             | P <sub>OUT</sub> =+24.0dBm/tone   |
| IM <sub>5</sub>  |      | -32                                | -30  | dBc             | P <sub>OUT</sub> =+24.0dBm/tone   |
| IM <sub>7</sub>  |      | -40                                |      | dBc             | P <sub>OUT</sub> =+24.0dBm/tone   |
| Two-Tone Current Drain   | 225  | 260                                | 350  | mA              |   |
| Two-Tone Power-Added Eff.  |      | 33                                 |      | %               |   |
| Power Control  |      |                                    |      |                 |   |
| Power Down "ON"  |      | V <sub>CC</sub>                    |      | V               | Voltage supplied to the input   |
| Power Down "OFF"   |      | 0                                  |      | V               | Voltage supplied to the input   |
| PD Input Current   |      | 3.7                                | 5.0  | mA              | Only in "ON" state  |
| Power Supply   |      |                                    |      |                 |   |
| Power Supply Voltage   |      | 2.7 to 6.5                         |      | V <sub>DC</sub> |   |
| Total Idle Current Drain   |      | 2                                  | 10   | μΑ              | V <sub>PD</sub> <0.1V <sub>DC</sub> , V <sub>CC</sub> =6.5V                                   |
|  |      | 60                                 |      | mA              | V <sub>PD</sub> =4.4V <sub>DC</sub> , V <sub>CC</sub> =6.5V                                   |
|  |      | 80                                 |      | mA              | V <sub>PD</sub> =5.0V <sub>DC</sub> , V <sub>CC</sub> =6.5V                                   |
|  | 80   | 100                                | 165  | mA              | V <sub>PD</sub> =5.8V <sub>DC</sub> , V <sub>CC</sub> =6.5V                                   |
|  |      | 120                                |      | mA              | $V_{PD} = 6.5 V_{DC}, V_{CC} = 6.5 V$   |

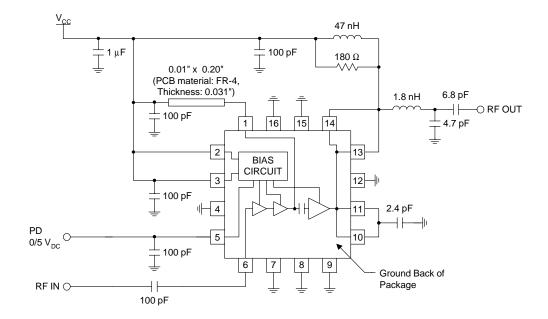
| Pin | Function | Description   | Interface Schematic |
|-----|----------|---|---------------------|
| 1   | VCC2     | Positive supply for the second stage (driver) amplifier. This is an unmatched transistor collector output. This pin should see an inductive path to AC ground (V <sub>CC</sub> with a UHF bypassing capacitor). This inductance can be achieved with a short, thin microstrip line or with a low value chip inductor (~2.7 nH). At lower frequencies, the inductance value should be larger (longer microstrip line) and V <sub>CC</sub> should be bypassed with a larger bypass capacitor (see the application schematic for 430 MHz operation). This inductance forms a matching network with the internal series capacitor between the second and third stages, setting the amplifier's frequency of maximum gain. An additional 1 $\mu$ F bypass capacitor in parallel with the UHF bypass capacitor is also recommended, but placement of this component is not as critical. In most applications, pins 1, 2, and 3 can share a single 1 $\mu$ F bypass capacitor. |                     |
| 2   | VCC3     | Positive supply for the active bias circuits. This pin can be externally combined with pin 3 (VCC1) and the pair bypassed with a single UHF capacitor, placed as close as possible to the package. Additional bypassing of $1\mu$ F is also recommended, but proximity to the package is not as critical. In most applications, pins 1, 2, and 3 can share a single $1\mu$ F bypass capacitor.  |                     |
| 3   | VCC1     | Positive supply for the first stage (input) amplifier. This pin can be externally combined with pin 2 (VCC3) and the pair bypassed with a single UHF capacitor, placed as close as possible to the package. Additional bypassing of $1\mu$ F is also recommended, but proximity to the package is not as critical. In most applications, pins 1, 2, and 3 can share a single $1\mu$ F bypass capacitor.   |                     |
| 4   | GND      | Ground connection. For best performance, keep traces physically short<br>and connect immediately to ground plane. In addition, for specified per-<br>formance, the package's backside metal should be soldered to ground<br>plane.  |                     |
| 5   | PD       | Power down control voltage. When this pin is at 0V, the device will be in power down mode, dissipating minimum DC power. When this pin is at $V_{CC}$ (3V to 6.5V), the device will be in full power mode delivering maximum available gain and output power capability. This pin may also be used to perform some degree of gain control or power control when set to voltages between 0V and $V_{CC}$ . It is not optimized for this function so the transfer function is not linear over a wide range as with other devices specifically designed for analog gain control; however, it may be usable for coarse adjustment or in some closed loop AGC systems. This pin should not, in any circumstance, be higher in voltage than $V_{CC}$ , nor should it ever be higher than 6.5V. This pin should also have an external UHF bypassing capacitor.   |                     |
| 6   | RF IN    | Amplifier RF input. This is a $50\Omega$ RF input port to the amplifier. It does<br>not contain internal DC-blocking and therefore should be externally<br>DC-blocked before connecting to any device which has DC present or<br>which contains a DC path to ground. A series UHF capacitor is recom-<br>mended for the DC-blocking.  |                     |
| 7   | GND      | Same as pin 4.  |                     |
| 8   | NC       | Not internally connected.   |                     |
| 9   | NC       | Not internally connected.   |                     |

| Pin         | Function      | Description   | Interface Schematic |
|-------------|---------------|---|---------------------|
| 10          | RF OUT        | Amplifier RF output. This is an unmatched collector output of the final amplifier transistor. It is internally connected to pins 10, 11, 13, and 14 to provide low series inductance and flexibility in output matching. Bias for the final power amplifier output transistor must also be provided through two of these four pins. Typically, pins 10 and 11 are connected to a network that creates a second harmonic trap. For 830MHz operation, this network is simply a single 2.4pF capacitor from both pins to ground. This capacitor series resonates with internal bond wires at two times the operating frequency, effectively shorting out the second harmonic. Shorting out this harmonic serves to increase the amplifier's maximum output power and efficiency, as well as to lower the level of the second harmonic output. Typically, pins 13 and 14 are externally connected very close to the package and used as the RF output with a matching network that presents the optimum load impedance to the PA for maximum power and efficiency, as well as providing DC-blocking at the output. An additional network of a bias inductor and parallel resistor provides DC bias and helps to protect the output from high voltage swings due to severe load mismatches. Shunt protection diodes are included to clip peak voltage excursions above ~15V to prevent voltage breakdown in worst case conditions. |                     |
| 11          | <b>RF OUT</b> | Same as pin 10.   |                     |
| 12          | GND           | Same as pin 4.  |                     |
| 13          | RF OUT        | Same as pin 10.   |                     |
| 14          | RF OUT        | Same as pin 10.   |                     |
| 15          | NC            | Not internally connected.   |                     |
| 16          | NC            | Not internally connected.   |                     |
| Pkg<br>Base | GND           | This contact is the main ground contact for the entire device. Care<br>should be taken to ensure that this contact is well soldered in order to<br>prevent performance from being degraded from that indicated in the<br>specifications.  |                     |

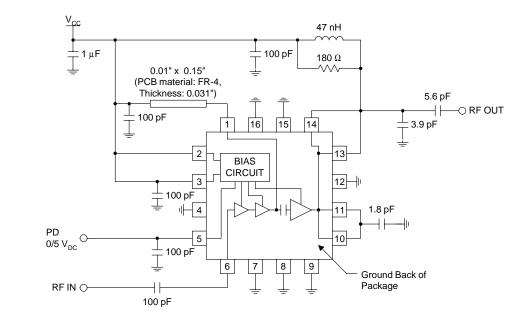
## Application Schematic for 430MHz Operation



### Application Schematic for 840MHz Operation



### Application Schematic for 915MHz Operation



Evaluation Board Schematic (840MHz) (Download <u>Bill of Materials</u> from www.rfmd.com.)

